506449047 01/14/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6495817

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DISHANT SRIVASTAVA	01/10/2021
BENJAMIN CAMPBELL	12/18/2020
JOEL LINSKY	01/05/2021
MAYANK BATRA	12/14/2020

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16990982	

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 7036217140

Email: meo.docket@mg-ip.com

Correspondent Name: MUNCY, GEISSLER, OLDS & LOWE, P.C./QC

Address Line 1: 4000 LEGATO ROAD, SUITE 310

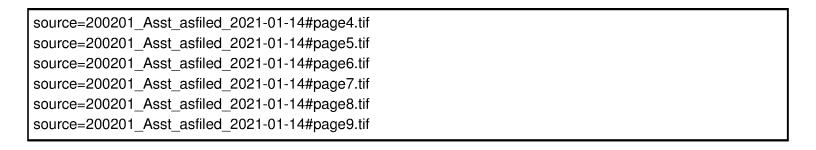
Address Line 4: FAIRFAX, VIRGINIA 22033

ATTORNEY DOCKET NUMBER:	QC200201
NAME OF SUBMITTER:	RENEE ELDER
SIGNATURE:	/RENEE ELDER/
DATE SIGNED:	01/14/2021

Total Attachments: 9

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PATENT 506449047 REEL: 054916 FRAME: 0735



ASSIGNMENT

WHEREAS, WE,

- 1. **Dishant SRIVASTAVA**, having a mailing address located at **5775 Morehouse Drive**, **San Diego**, **CA** 92121-1714,
- 2. Benjamin CAMPBELL, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 3. **Joel LINSKY**, having a mailing address located at **5775 Morehouse Drive**, **San Diego**, CA **92121-1714**,
- 4. Mayank BATRA, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **LATENCY REDUCTION** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/990,982 filed August 11, 2020, Qualcomm Reference Number 200201, and all provisional applications relating thereto (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE,

Its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof:

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at CANGACON 10 01 20 2

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	City, State	Dede	Benjamin CAMPBELL	
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	City, State	Dete	Jost LINSKY	
Oene s	s <u>,</u> m			
	Cav, State	Diste	Mayank BATRA	

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Done at		, on	
	City, State	Date	Dishant SRIVASTAVA

PATENT Qualcomm Reference Number: 200201 Page 3 of 3

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Done at .	City, State	Date	Benjamin CAMPBELL
Done at ,	Sen Dego, l City, State	4, on 1/5/21	Joel LINSKY
Done at	eny, out	GR GR	
Done at	City State	Date	Mayank BATRA

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	City, State	Date	Dishant SRIVASTAVA

PATENT

Qualcomm Reference Number: 200201

Page 3 of 3

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Done at _		, on	
	City, State	Date	Benjamin CAMPBELL
Done at		, on	
	City, State	Date	Joel LINSKY
Done at C	'AMBRIOGE,UK	C, on 14 DECEMBER 2020	Mayank Batro
	City, State	Date	Mayark BATRA

PATENT REEL: 054916 FRAME: 0745

RECORDED: 01/14/2021